

AMP-LATCH | AMP-LATCH Universal Headers

TE Internal #: 102153-8

AMP-LATCH Universal Headers, Ribbon Cable Connectors, Board-to-Board, 34 Position, 2.54mm [.1in] Centerline, Vertical, Through

Hole - Solder
View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors



Connector System: Board-to-Board

Number of Positions: 34

Centerline (Pitch): 2.54 mm [.1 in]
PCB Mount Retention: Without

PCB Mount Retention Type: Screw Mount

Features

Product Type Features

Treadet Type reduces	
Connector Type	Header
Ribbon Cable Connector Header Type	Universal Ejection Pin Headers
Connector Product Type	Connector Assembly
Connector System	Board-to-Board
Connector & Housing Type	Receptacle
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Positions	34
PCB Mount Orientation	Vertical
Number of Rows	2
Electrical Characteristics	

Insulation Resistance	5000 MΩ
Operating Voltage	250 VAC

Body Features

Daisy Chain	Without
Connector Profile	Standard

Contact Features

Mating Square Post Dimension	.64 mm[.025 in]
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PCB Contact Termination Area Plating Material Thickness	2.54.um[100.uin]
	2.54 μm[100 μin] Pin
Contact Type	15 – 15 μin
Contact Mating Area Plating Material	·
Contact Mating Area Plating Material	Gold, Gold Flash
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Brass, Phosphor Bronze
Contact Current Rating (Max)	1 A
Termination Features	
Round Termination Post & Tail Diameter	.64 mm[.025 in]
Termination Post & Tail Length	2.79 mm[.11 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	With
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	Without
PCB Mount Retention Type	Screw Mount
Mating Alignment Type	Center, Dual Polarizing Bar
Mating Retention	Without
Connector Mounting Type	Board Mount
Housing Features	
Housing Material	Thermoplastic
Housing Color	Black
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Shrouded End Dimension	3.81 mm[.15 in]
Connector Height	13.94 mm[.55 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Usage Conditions	



Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Operation/Application	
Solder Process Feature	Solder Dipped
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	50
Packaging Method	Tray

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Not Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2020 (205) Candidate List Declared Against: JAN 2020 (205) Pb (13% in Component Part)
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2020 (205) Candidate List Declared Against: JAN 2020 (205)
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An

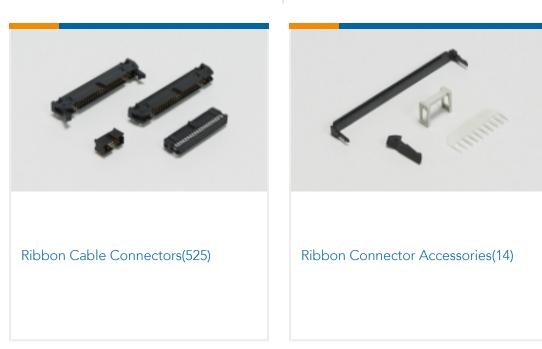


Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

Compatible Parts



Also in the Series | AMP-LATCH Universal Headers

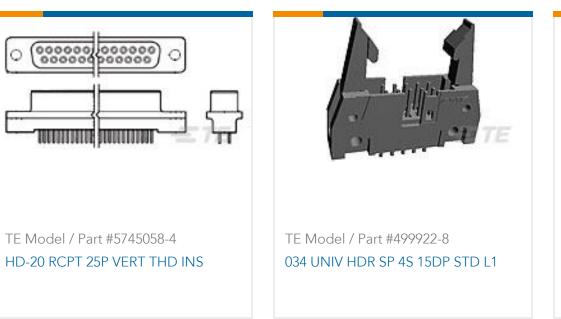


Customers Also Bought





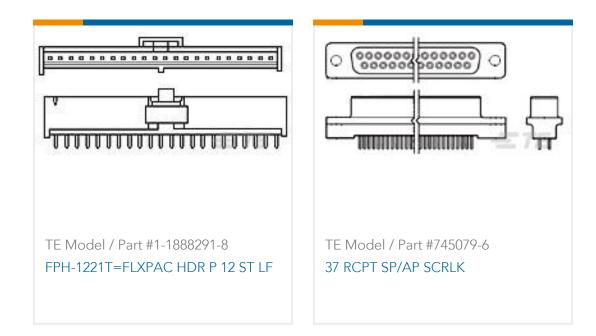












Documents

Product Drawings

034 UNIV HDR SP 4S 15DP STD

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_102153-8_M.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_102153-8_M.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_102153-8_M.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

English

Product Environmental Compliance

TE Material Declaration

English

Instruction Sheets

Instruction Sheet (U.S.)

English

AMP INSTALLATION PROCEDURES FOR AMP-LATCH UNIVERSAL HEADER ASSEMBLIE

English

Agency Approvals

Agency Approval Document

English